Summary of 'Cavity Production and Integration'

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Definition of work area

Cavity preparation & process

Gradient (S0 task), Surface Treatment procedure, Shape (TESLA shape, LL, re-entrant, others), Input coupler port diameter, HOM performance, Wake of HOM antenna and Input coupler antenna, Flange seal method, Cavity Fabrication method, Materials and thickness (High Pressure Vessel regulation), Pre-tuning procedure (method, target, specifications), Vertical test, Cavity fixture (support), ...

Cavity package

Tuner, Piezo maintenability, Lorentz detuning compensation, Tuner motor maintenability (motor inside/outside), Coupler (variable coupling/fixed coupling), Magnetic shielding method (inside or outside vessel), High Pressure Vessel regulation, Helium vessel material and thickness (Ti or SUS, ...),

Alignment method, Assembly procedure in clean room, HOM probe, monitor antenna, Coupler peripherals(arc sensor, temp sensor, pumping, coupling adjuster, etc), ...

Cavity Kick-off-meeting

Sep.19-21, 2007 at DESY

- Review of BCD R&D activity during RDR RDR cavities, S0 task, US activities, KEK activities
- Review of Alternatives
 shape, vertical EP and High Peak Power Process, cavity materials
- Recent research activities surface process, HF free EP
- Industrialization plan of XFEL
- Discussion of plug compatible concept
- Discussion of work package
- Evaluation of Survey

Strategy of cavity package design

1. Baseline Engineering Design

decision of Unified Parameters (gradient, HOMs, detuning compensation ...). down-selection of technologies (cavity shape, tuners, couplers,). decision/selection of detailed engineering.

2. Baseline Fabrication & Qualification Procedure decision on fabrication method, qualification/test procedure.

3. Cost Evaluation of Baseline Engineering Design

re-evaluation of cost if the design is changed from RDR. The evaluated cost will be the reference for plug-in's cost.

4. Plug-in specification if candidates are there

Pick-up possible plug-in compatible components(parts), decision of plug-in performance spec., dimension spec., interface spec., material spec., qualification/test spec., installation spec., transportation spec., ...

Technology down-selection

- 1. Identify the down-selection item.
- 2. Identify the proposal & proposer of the technology.
- 3. Make comparison tables for advantages & disadvantages from each proposer.
- 4. PM Make fair-minded comparison table to be filled in by each proposer.
- 5. PM decide the technology according to the table.

Example of comparison table

Slow Tuner										
		TTF		STF	STF					
		Saclay -1	Blade	Slide Jack	Ball Screw					
			Lifetime Test (~ 0.1mm x 10	0000 Times) is necessar	y.					
Mechanism		Double Lever	Blade+Lever+Screw Wedge+Screw+Gear		Screw+Worm Gear					
			Blade has the potential Problem of Fatigue.		Life time of Coating?					
Stiffens	N/μm	40	25	290	1000					
		Not Stiff	Not Stiff. If used to TESLA Cavity DLD at Flat-Top becomes ~900Hz.							
Stroke	mm		< 2	3.5	Long enough					
Location		Beam Pipe	Jacket Cylinder	Jacket Cylinder	Jacket Cylinder					
		The room for tuner is small. Top Heavy. Alignment?								
Cost										









			Fast Tuner					
		TTF		STF	STF			
		Saclay -1	Blade	Slide Jack	Ball Screw			
		Piezo(200V)	Piezo(200V)	Piezo(150V)	Piezo+Blade			
			Speed ?		Blade has the potential Problem of Fatigue. Speed ?			
		NORIAC (1 Spare)	NORIAC (1 Spare)	Piezo Mechanic x 1	Piezo Mechanic x 1			
Size	mm	10 x 10 x 26	10 x 10 x 38	φ20 x 18				
Stiffness N / μm		n 105	70	500				
Max. Load	kN	4	4	14				
Stroke:RT	μm	40	60	20				
Stroke:2k	Stroke:2k μm		6	2				
Compensation	μm	3.4	6	1				
Speed								
Delay		0.6 msec.						
			 Repairability	y				
Motor r		need Disassemble	need Disassemble	Outside	Poor			
Piezo		need Disassemble	need Disassemble	Repairable	need Disassemble			
			US Study	on this Subject exists.				
	How to check Piezos just we install. There are no experience for long term operation in Pulsed mode. Life time Test is necessary.							

Possible plug-compatible units

C1-level: Cryomodule

C2-level: Cryostat with GRP, He-pipes, and thermal shields.

C3-level: Cryostat vessel, GRP supports, Pipes, Thermal Shields, Invar fixture,

Cavity support, Quad support, Cryostat Pumping system,

Instruments(vacuum, temperature, etc)

Installation fixture and method,

Transportation fixture and method,

C2-level: Cavity package with He jacket, tuner and coupler,

C3-level: Cavity, Jacket, Magnetic shield, Tuner, Coupler,

Instruments (RF cable, temperature sensor, piezo drive, etc)

C2-level: Quad-steer-BPM package,

C3-level: Quad magnet, Steer dipole coils, Current feedthrough, BPM

C2-level: HOM absorber

C2-level: Beam line pumping

FNAL Pipes

FNAL Jacket

DESY cavity

For example;

KEK tuner

Cavity Cryomodule Cryogenic parallel session

Oct.23-24, 2007 at DESY

- Discussion of <u>specification profile table</u> which allow a plug compatible concept & boundary conditions
- EDR strategy (R. Stanek)
- Discussion of work package

Example of Specification tables which allow a plug-compatible concept (1)

	tuner	specification item	Rough guess	unit and comments	
	Slow tuner	Tuning range	>600	kHz	
		Hysteresis in Slow tuning	<10	μm	
		Motor requirement	step-motor use, Power-off Holding, magnetic shielding		
		Motor specification	ex) 5 phase, xxA/phase, É	match to driver unit, match to connector pin asignment,É	
Slo	w Tuner	Motor location			
		Magnetic shielding	<20	mG at Cavity surface, average on equater	discuss later
		Heat Load by motor	<50	mW at 2K	discuss later
		Physical envelope	do not conflict with GRP, 2-phase line, vessel support, alignment references, Invar rod, flange connection,É		cable connection, Mag shield
		Survive Frequency Change in Lifetime of machine	~20 Mio. steps	could be total number of steps in 20 years,	

[•]Table is under developing

Example of Specification tables which allow a plug-compatible concept (2)

Fast Tuner

ast Tuner —				
Fast tuner	Tuning range	>1	kHz over flat-top at 2K	
	Lorentz detuning			
	compensation	<100	Hz at 31.5MV/m flat-top	
			match to driver unit,	
			match to connector pin	
	Actuator specification	0-1000V, E	asignment, É	decide later
		insdie 4K?/inside 4K		
		accessible/inside		
		100K? accesible /		
		inside 300K accessible		
	Actuator location	from outside?		decide later
			mG at Cavity surface	
	Magnetic shielding	<20	average	
			l	measure first, discuss
	Heat Load in operation		mW	later
		do not conflict with		
		GRP, 2-phase line,		
		vessel support,		
		alignment references, Invar rod, flange		
	Physical envelope	connection,É		
	1 Hysical Chivelope	CONTICCTION, E	number of pulses over	
	Survive Frequency		20 years,	
	Change in Lifetime of		(2x109:operational	
	machine	>10 ¹⁰	number)	

Under developing

Example of Specification tables which allow a plug-compatible concept (3)

specification items	condition		unit and comments		
Power requirements	Operation	>400	kW for 1300 us		
				need after vac break,	
	Proccessing	>1000	kW upto 400 us	cool-down	
•				need after vac break,	
oupler		>600	kW larger than 400 us	cool-down	
	Processing with				
	reflection mode	>600	kW for 1300us	in Test stand	
	TOHOULON MOGO		NV 101 1000ac	iii root otaria	
Processing time	warm	<50	hours	after installation	
	cold		hours	after installation	
Heat loads /coupler	2K static	<0.1	W		should get Tom'snumber later
'	5K static	<0.5	W	depend on tunability	should get Tom'snumber later
	80 K static		W	'	should get Tom'snumber later
	5K dynamic	<0.3	W		should get Tom'snumber later
	80K dynamic	<3	W		should get Tom'snumber later
Cavity vacuum integrety		2	# of windows		
			bias capablity	decide later	
RF Properties	Qext		tunable	decide later	
_	Tuning range	1-10	10^6 if tunable	decide later	
Physical envelope	Position		compatible to TTF-III	decide later	
<u>'</u>	Flange		compatible to TTF-III	decide later	to cavity, to cryostat
	waveguide		compatible to TTF-III	decide later	
	support		compatible to TTF-III	decide later	
Instrumentation					
vacuum level	-	>1		+	+
spark detection		<u> </u>	at window		+
spark detection		0	at willuow		1
electron current detection		>1	at coax		•Under developing
temperature		>1	at window		

EDR strategy discussion for cavities and cryomodules By R. Stanek

Summary:

- Cavity & cryomodule design effort would like to
 - Arrive at a consensus design for an ILC cryomodule
 - Build on the anticipated success of XFEL project
 - Utilize the components that give the best chance for success
- Due to uncertainty in project start date, current inability to meet ILC cavity requirements (gradient & yield) and a general influx of new ideas (cost reduction/reliability), EDR phase will face multiple decision paths in its design process
- Important to contain the design work within acceptable parameter space
- This process needs to be open and responsive to the requirements and plans of each Region
- Need to decide, will we have a <u>unified design</u> or a <u>plug compatible</u> <u>design?</u>
- Design changes must be validated
- Opportunities to test these changes (in cryomodules or with beam) will be limited in the EDR phase
- There is a general consensus on how extensive these validation tests need to be (survey results)
- Combination of feedback from test facilities, time to implement design changes, and validation testing requirements => results in a final ILC cryomodule design available after the EDR phase is complete
 - If the design is Region dependent, things change

Survey Results (abbreviated)

Validation Survey	NOTE: Va	IOTE: Vallidation tests occur after all R&D and prototype work is complete & design change is mature enough to be considered as change to baseling												
If you make a change in this →	Cavity Shape LL OR RE	Cavity Material Large Small Grain	Magnet Shield Location	Quad Design	Quad Position	BPM Design	He Vesssel SS vs. Ti	Tuner Design	Coupler Design	Pipe Size (dia)	Rad Shield Design	Support Design Transport fixture	Instrume ntation	Align System
You validate the														
change by doing this Į														
Can design change be made without testing? (Y/N)	N	N	N	N	N (few Y)	N	N	N	N	Y (few N)	Split	N	N	N
Number of components fabricated & tested?	24-30	30	10	1-3	3	3	24-30	10	24	1	1-3	1-3	1	1
Does design change require only component level testing? (Y/N) Component level testing equals Vert or Horiz testing or cycle test	N	Y (V&H)	N	N	N	N	Split (H)	N	N	N	Split	N	N	N
Hours of component level testing?		1000hrs		40hrs		500hrs	1000hrs	1000hrs	1000hrs			250 hrs	250 hrs	
Does design change require testing in cryomodules (without beam)? (Y/N)	Υ	N	Y	Υ	Υ	Υ	Y (few N)	Υ	Υ	Υ	Υ	Υ	Υ	Υ
Number of cryomodules?	3		1	1	3	3	3	1-3	3	1	1	1-3	1.3	1
Does design change require testing in RF Unit/String test (with beam)? (Y/N)	Υ	N	N	N	Split	Υ	N	Split	Split	N	N	N	N (few y)	N
Hours of string testing?	1000hrs	0	0	0	1000hrs	1000hrs	0	1000hrs	500hrs	0	0	0	100hrs	0

Results from survey can be used to identify dependencies in design schedule

Proposed Work Package

Cavity package

WP-CP1. Cavity Tuner

Tuner Selection (Saclay tuner, Brade tuner, Slide-jack tuner, Ball-screw tuner,... Fast tuner selection)
Lorentz detuning compensation (specification, method, required rigidities, fast tuning specification,...)
[Selection at end of 2008], then detail engineering design.

WP-CP2. Cavity coupler

Coupler selection (variable coupling, fixed coupling, port diameter, ...)

[Selection of fixed/variable coupling at end of 2008], then detail engineering design.

WP-CP3. Cavity Magnetic shield

Magnetic shielding method (inside or outside vessel)

[Selection of magnetic shield inside/outside at end of 2008], then detail engineering design.

WP-CP4. Cavity vessel

Vessel material (material selection, metal junctions, HPV regulation) including alignment method. [Engineering design detail at end of 2009]

WP-CP5. Cryomodule Operation (S1 task)

Demonstration of 31.5MV/m operation by at least one cryomodule. [demonstration by end of 2009]

Plan for developing WPs and Spec. tables

- Call of EOI for proposed WP, ~next week.
- Develop WP, with interested Institute, with resource(?), ~end of November.
- Revise specification profile table, ~end of November.
- Finalize WP & spec. tables, Feb.2008

3 - 7 March, ILC-GDE meeting at Sendai